

IN THE CLAIMS:

Please amend the claims as follows.

1. (Currently Amended) A stock sheet for a flexible wiring board comprising:
a flexible sheet-like substrate configured to be transported in a predetermined direction, and
a plurality of wiring patterns arranged on the substrate in a ~~predetermined~~ direction
perpendicular to the predetermined direction, on the substrate and wherein the plurality of
wiring patterns correspond to ~~corresponding to patterns on~~ individual layers of wiring
~~boards of~~ a multilayer flexible wiring board.
2. (Cancelled).
3. (Withdrawn) A mask for exposure used in a photoetching process, comprising a sheet-like
mask body, and a plurality of pattern holes arranged in a predetermined direction in the mask
body and corresponding to individual layers of wiring boards of a multilayer flexible wiring
board.
4. (Withdrawn) The mask of claim 3 wherein each pattern hole is arranged in a direction
perpendicular to a transporting direction of the mask body.
5. (Withdrawn) The mask of claim 3 wherein each of the pattern holes corresponds to a wiring
pattern.
6. (Withdrawn) The mask of claim 4 wherein each of the pattern holes corresponds to a wiring

pattern.

7. (Withdrawn) A method for manufacturing a multilayer flexible wiring board comprising:
using a mask for exposure in which a plurality of pattern holes corresponding to individual layers of wiring boards of a multilayer flexible wiring board are arranged in a predetermined direction in a sheet-like mask body; and exposing the mask body to light while it is transported in a predetermined direction.
8. (Withdrawn) The process of claim 7 wherein each pattern is arranged in a direction perpendicular to a transporting direction of the mask body.
9. (Withdrawn) The process of claim 7 wherein each of the pattern holes corresponds to a wiring pattern.
10. (Withdrawn) The process of claim 8 wherein each of the pattern holes corresponds to a wiring pattern.